

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	29	SONDERMAN-T SONDERMAN-THOMAS SONDERMAN-THOMAS-J SONDERMAN-T-J SONDERMAN-T-S	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/01/29 14:27
S2	3	BUSHMAN-SCOTT	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/01/29 14:59
S3	1	BUSHMAN-SCOTT-G	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/01/29 15:01
S4	1	BUSHMAN-S-G	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/01/29 15:04
S5	16	CHRISTIAN-CRAIG-WILLIAM CHRISTIAN-CRAIG-W	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/01/29 15:07
S6	13	(CHRISTIAN-CRAIG-WILLIAM CHRISTIAN-CRAIG-W) not (SONDERMAN-T SONDERMAN-THOMAS SONDERMAN-THOMAS-J SONDERMAN-T-J SONDERMAN-T-S)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/01/29 15:11
S7	638	700/121.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/01/29 16:59
S8	265	700/121.ccls. and deposit\$5	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/01/29 15:12
S9	146	700/121.ccls. and deposit\$5 and rate	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/01/29 15:20

S10	81	700/121.ccls. and deposit\$5 and rate and thick\$5	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/01/29 15:39
S12	61	700/123.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/01/29 16:59
S13	1982	(semiconductor or wafer) and ((deposit\$5 with rate) same thick\$5 same time)	US-PGPUB; USPAT	OR	ON	2003/01/29 17:53
S14	621	(semiconductor or wafer) and ((deposit\$5 with rate) with thick\$5 with time)	US-PGPUB; USPAT	OR	ON	2003/01/29 17:57
S15	2	(semiconductor or wafer) and ((deposit\$5 with rate) with thick\$5 with time with model)	US-PGPUB; USPAT	OR	ON	2003/01/29 18:52
S16	432	(sputter\$5 with target with (life or lives))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/10/23 13:52
S17	7	"sputter target life"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/10/23 13:50
S18	95	(sputter\$5 with target with (life or lives)) and rate and power and time and (model\$5 or function)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/10/23 15:06
S19	8	((sputter\$5 with target with (life or lives)) and rate and power and time and (model\$5 or function)) and (rate with sensor)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/10/23 15:06
S26	22	(deposit\$6 near rate) same sputter\$6 same model\$6 same (power or time)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/18 16:42
S27	764	((target or cathode or anode) near (life or live or age or consumption)) same (sputter\$6 or deposition)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/02 22:17

S28	178	((target or cathode or anode) near (life or live or age or consumption)) same (sputter\$6 or deposition) same rate	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/02 22:17
S29	225	((target or cathode or anode) near (life or live or age or consum\$7)) same (sputter\$6 or deposition) same rate	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/02 22:18
S30	314	((target or cathode or anode) near2 (life or live or age or consum\$7)) same (sputter\$6 or deposition) same rate	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/02 22:20
S31	340	((target or cathode or anode) near2 (life\$6 or live or age or consum\$7)) same (sputter\$6 or deposition) same rate	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/02 22:23
S32	29	((target or cathode or anode) near2 (life\$6 or live or age or consum\$7)) same (sputter\$6 or deposition) same rate same (model\$6 or function\$5 or formula)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/03 16:05
S33	1	(sputter\$6 or deposition) with (rate near sensor) with (model\$6)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/03 16:06
S34	46	(sputter\$6 or deposition) with (rate near sensor)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/03 16:06
S35	71	(sputter\$6 or deposition) with (rate near2 sensor)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/03 16:48
S37	32	sputter\$6 same (rate near sensor)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/03 18:25
S38	38	sputter\$6 same (rate near2 sensor)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/03 18:29

S39	6	S38 not S37	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/03 18:25
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